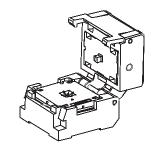
Burn-In Sockets QMC Series CLAMSHELL QFN SOCKET

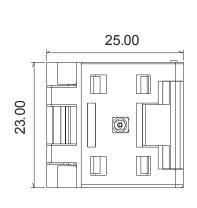


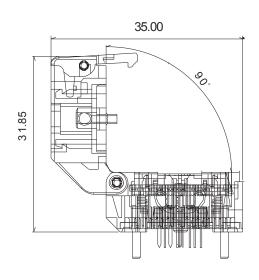


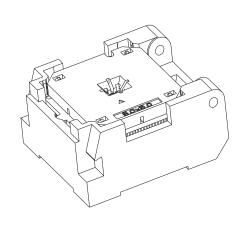
Universal ClamShell Style for Thru-Hole mount Individual spring loaded pressure pad per device type Inexpensive GP insert accommodates many package sizes Opening provided on top for sensor placement X-shape stand-off prevents package from sticking Accommodate 0.5~1.2mm thick packages (See pages 14/15 for Open Top style)



Please note, we will always request the chip data to ensure we offer a compatible socket.







You may request any specific socket dimension from info@e-tec.com

> For top view socket dimension pls. ref. to separate catalog page

Specifications

Mechanical data

Contact life Contact Normal Force Operation Force 2.0Kg max

Material

Insulator (RoHS compliant)

Contact (RoHS compliant) Contact plating

15,000 cycles 5-8g Per Pin

PES, PEI Beryllium Copper Alloy Gold cover Nickel

Electrical data

Contact resistance $< 30 \text{ m}\Omega$ Current rating Insulation resistance at 500V DC 1,000 mΩ

Operating temperature -55°C to +175°C

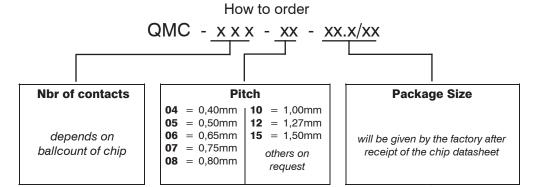
Recommendations:

Solder paste - Please use a solder paste w/o any silver!

Solder profile - Please refer to our website www.e-tec.com

E-tec solderless sockets are adapted to a standard PCB thickness of 1.60mm. For a different PCB thickness, please inform E-tec first! For high pincount SMT sockets, E-tec recommends the use of a pluggable thru-hole socket mounted into a MiniGrid Adapter (see also page 10, 11 & 12 for more details)

For SMT sockets in general, E-tec recommends the use of locating pegs which can be soldered to the PCB for added mechanical strength.

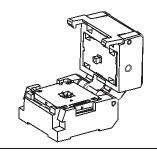


Burn-In Sockets QMC Series CLAMSHELL QFN SOCKET





Universal ClamShell Style for Thru-Hole mount Individual spring loaded pressure pad per device type Inexpensive GP insert accommodates many package sizes Opening provided on top for sensor placement X-shape stand-off prevents package from sticking Accommodate 0.5~1.2mm thick packages (See pages 14/15 for Open Top style)



Please note, we will always request the chip data to ensure we offer a compatible socket.

Pitch	No. of Contacts	Pad Matrix	Package Size(mm)	Part Number
0.4	12	odd	2x2	QMC-012-04-2.0/2
	16	even	3x3	QMC-016-04-3.0/3
	20	odd	3x3	QMC-020-04-3.0/3
	24	even	4x4	QMC-024-04-4.0/4
	28	odd	4x4	QMC-028-04-4.0/4
	32	even	5x5	QMC-032-04-5.0/5
	36	odd	5x5	QMC-036-04-5.0/5
	40	even	5x5	QMC-040-04-5.0/5
	44	odd	6x6	QMC-044-04-6.0/6
	48	even	6x6	QMC-048-04-6.0/6
	52	odd	7x7	QMC-052-04-7.0/7
	56	even	7x7	QMC-056-04-7.0/7
	60	odd	8x8	QMC-060-04-8.0/8
	64	even	8x8	QMC-064-04-8.0/8
	76	odd	9x9	QMC-076-04-9.0/9
	80	even	9x9	QMC-080-04-9.0/9
	84	odd	10x10	QMC-084-04-10.0/10
	88	even	10x10	QMC-088-04-10.0/10
	104	even	12x12	QMC-104-04-12.0/12
	108	odd	12x12	QMC-108-04-12.0/12
0.5	12	odd	2x2	QMC-012-05-2.0/2
	16	even	3x3	QMC-016-05-3.0/3
	12	odd	3x3	QMC-012-05-3.0/3
	20	odd	3x3	QMC-020-05-3.0/3
	24	even	4x4	QMC-024-05-4.0/4
	20	odd	4x4	QMC-020-05-4.0/4
	32	even	5x5	QMC-032-05-5.0/5
	28	odd	5x5	QMC-028-05-5.0/5
	40	even	6x6	QMC-040-05-6.0/6
	36	odd	6x6	QMC-036-05-6.0/6
	48	even	7x7	QMC-048-05-7.0/7
	44	odd	7x7	QMC-044-05-7.0/7
	56	even	8x8	QMC-056-05-8.0/8
	52	odd	8x8	QMC-052-05-8.0/8
	64	even	9x9	QMC-064-05-9.0/9
	60	odd	9x9	QMC-060-05-9.0/9
	72	even	10x10	QMC-072-05-10.0/10
	68	odd	10x10	QMC-068-05-10.0/10
	88	even	12x12	QMC-088-05-12.0/12
	84	odd	12x12	QMC-084-05-12.0/12